



PMCM6501VPE

12 V, P-channel Trench MOSFET

10 August 2015

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a 6 bumps Wafer Level Chip-Size Package (WLCSP) using Trench MOSFET technology.

2. Features and benefits

- Low threshold voltage
- Ultra small package: $0.98 \times 1.48 \times 0.35$ mm
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection > 2 kV HBM

3. Applications

- Battery switch
- High-speed line driver
- Low-side loadswitch
- Switching circuits

4. Quick reference data

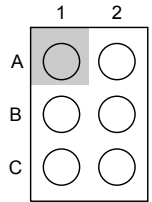
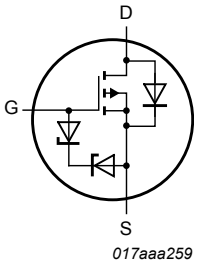
Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|--|-----|-----|------|------|
| V_{DS} | drain-source voltage | $T_j = 25$ °C | - | - | -12 | V |
| V_{GS} | gate-source voltage | | -8 | - | 8 | V |
| I_D | drain current | $V_{GS} = -4.5$ V; $T_{amb} = 25$ °C; $t \leq 5$ s | [1] | - | -8.2 | A |
| Static characteristics | | | | | | |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = -4.5$ V; $I_D = -3.0$ A; $T_j = 25$ °C | - | 19 | 25 | mΩ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--|--|
| A1 | G | gate |  <p>Transparent top view WLCSP6 (OL-PMCM6501VPE)</p> |  <p>017aaa259</p> |
| A2 | S | source | | |
| B1 | S | source | | |
| B2 | S | source | | |
| C1 | D | drain | | |
| C2 | D | drain | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|---------|--|----------------|
| | Name | Description | Version |
| PMCM6501VPE | WLCSP6 | WLCSP6: wafer level chip-size package; 6 bumps (3 x 2) | OL-PMCM6501VPE |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMCM6501VPE | AD |

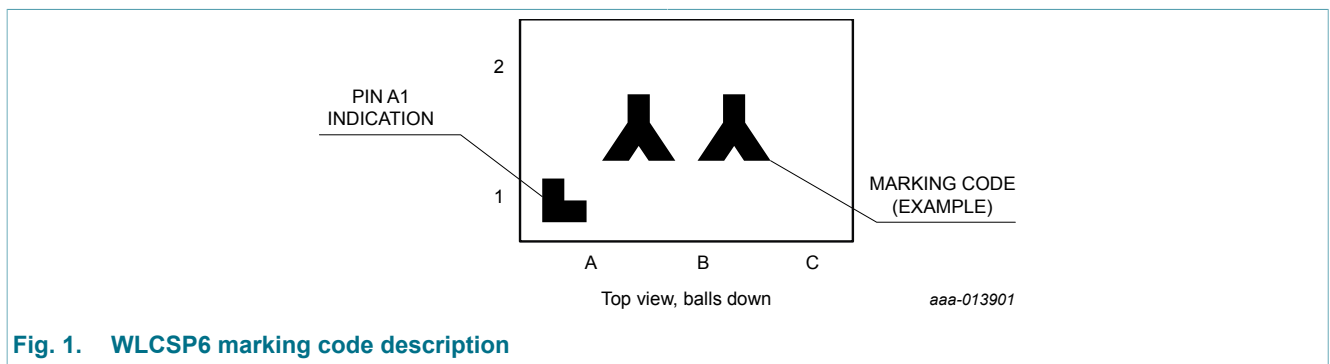


Fig. 1. WLCSP6 marking code description

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---------------------------|-------------------------|---|-----|-----|-------|------|
| V_{DS} | drain-source voltage | $T_j = 25\text{ °C}$ | | - | -12 | V |
| V_{GS} | gate-source voltage | | | -8 | 8 | V |
| I_D | drain current | $V_{GS} = -4.5\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | - | -8.2 | A |
| | | $V_{GS} = -4.5\text{ V}; T_{amb} = 25\text{ °C}$ | [1] | - | -6.2 | A |
| | | $V_{GS} = -4.5\text{ V}; T_{amb} = 100\text{ °C}$ | [1] | - | -4 | A |
| I_{DM} | peak drain current | $T_{amb} = 25\text{ °C}; \text{single pulse}; t_p \leq 10\text{ }\mu\text{s}$ | | - | -25 | A |
| P_{tot} | total power dissipation | $T_{amb} = 25\text{ °C}$ | [2] | - | 556 | mW |
| | | | [1] | - | 1300 | mW |
| | | $T_{sp} = 25\text{ °C}$ | | - | 12500 | mW |
| T_j | junction temperature | | | -55 | 150 | °C |
| T_{amb} | ambient temperature | | | -55 | 150 | °C |
| T_{stg} | storage temperature | | | -65 | 150 | °C |
| Source-drain diode | | | | | | |
| I_S | source current | $T_{amb} = 25\text{ °C}$ | [1] | - | -1.2 | A |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm^2 .
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

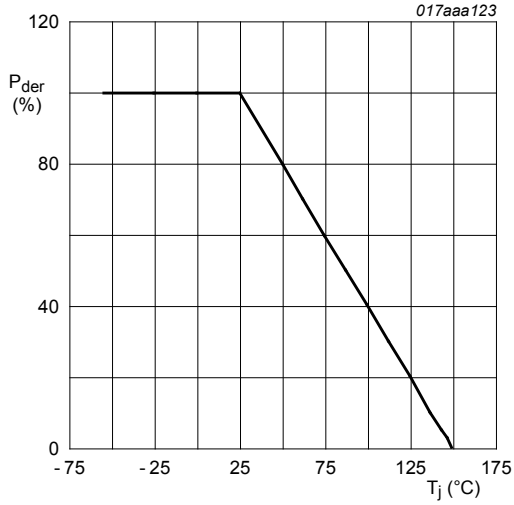


Fig. 2. MOSFET transistor: Normalized total power dissipation as a function of junction temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ C)}} \times 100 \%$$

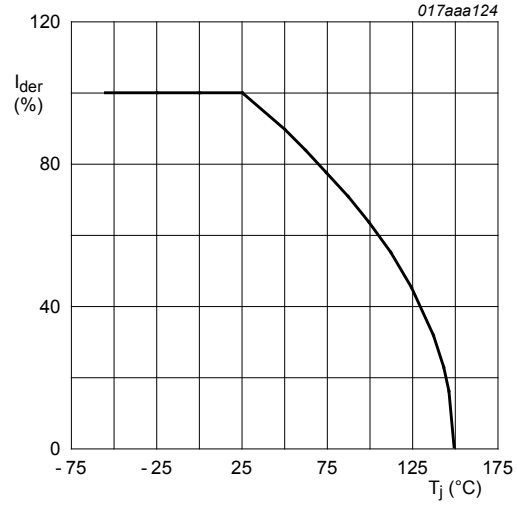
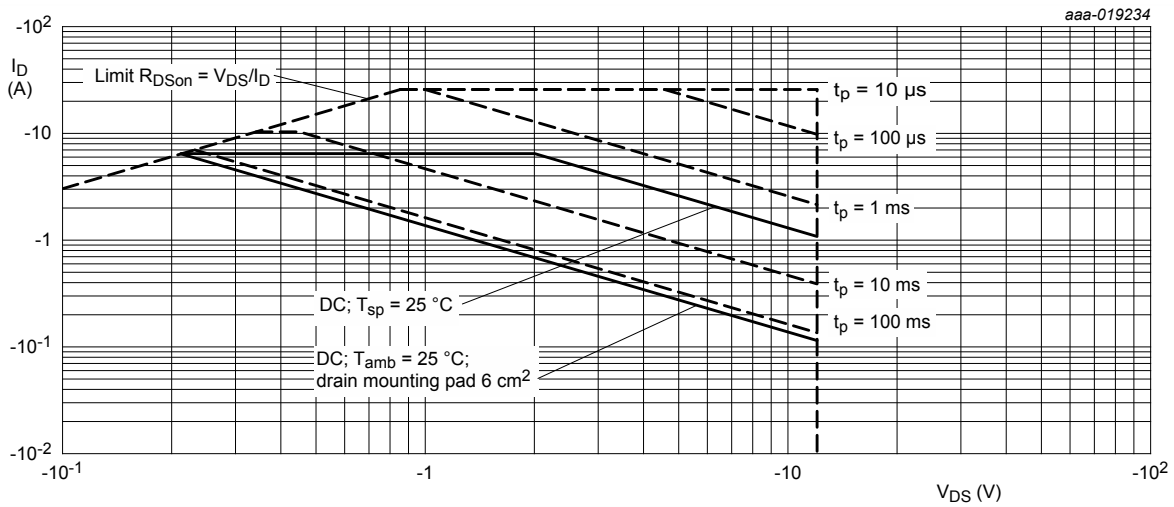


Fig. 3. MOSFET transistor: Normalized continuous drain current as a function of junction temperature

$$I_{der} = \frac{I_D}{I_{D(25^\circ C)}} \times 100 \%$$



I_{DM} = single pulse

Fig. 4. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------------|---|-------------|-----|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | [1] | - | 180 | 225 | K/W |
| | | | [2] | - | 65 | 85 | K/W |
| | | | [3] | - | 75 | 95 | K/W |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|----------------|--|---------------------------|-----|-----|-----|------|-----|
| | | in free air; $t \leq 5$ s | [3] | - | 45 | 55 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | - | 5 | 10 | K/W | |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 4-layer 1 cm².
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².

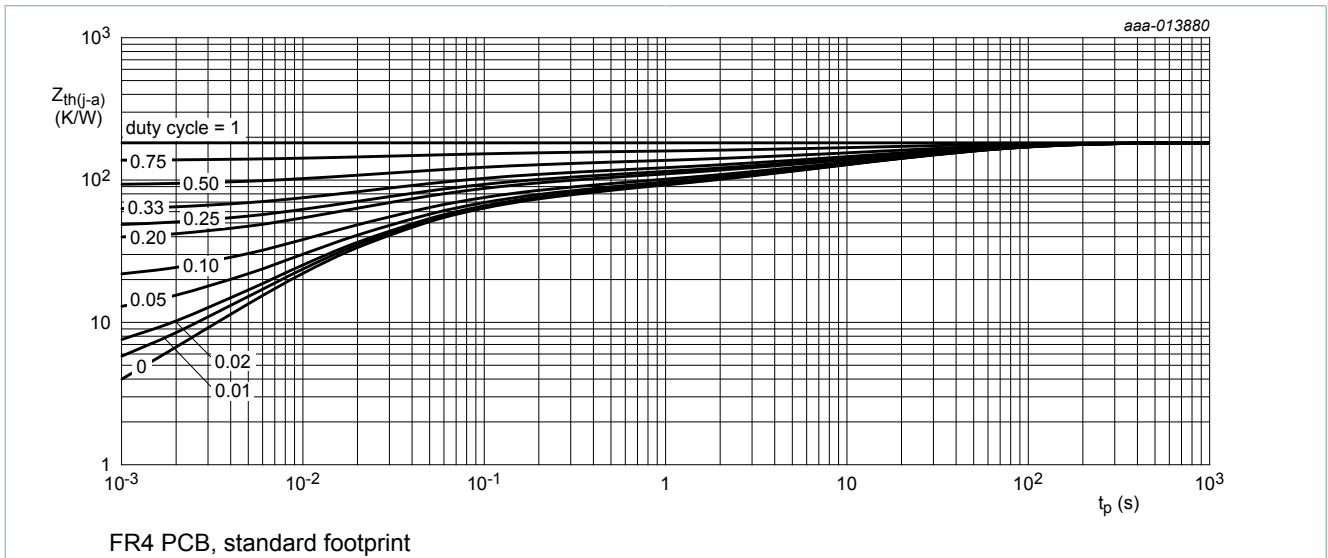


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

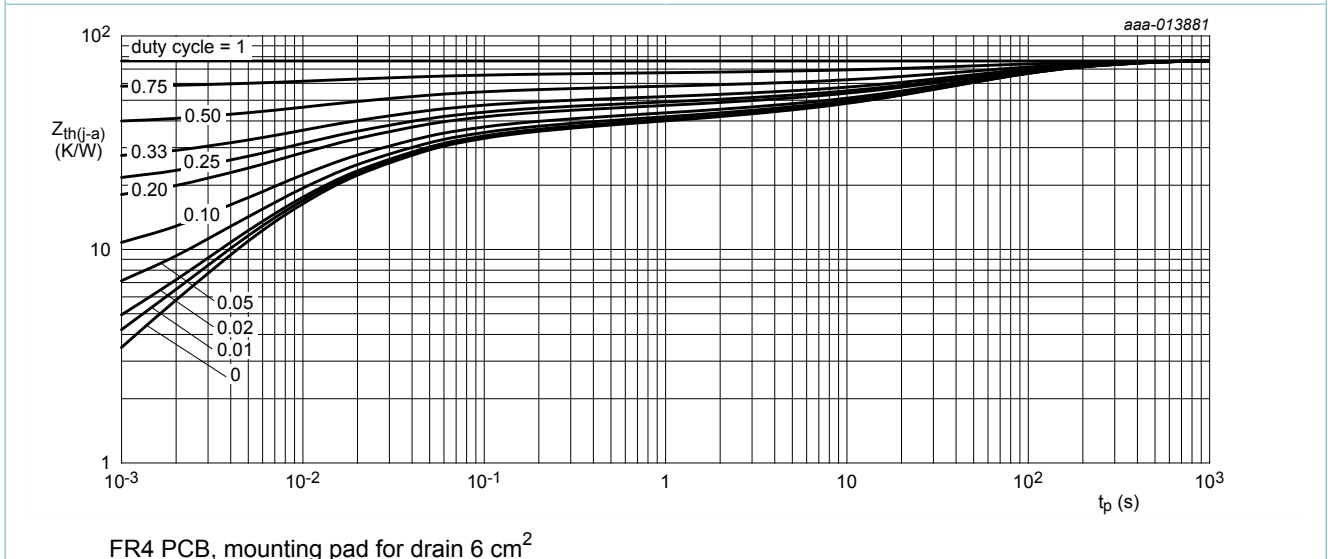


Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|----------------------------------|---|------|------|------|------------|
| Static characteristics | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D = -250 \mu A$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | -12 | - | - | V |
| V_{GSth} | gate-source threshold voltage | $I_D = -250 \mu A$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ }^\circ C$ | -0.4 | -0.6 | -0.9 | V |
| I_{DSS} | drain leakage current | $V_{DS} = -12 V$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | -1 | μA |
| I_{GSS} | gate leakage current | $V_{GS} = -8 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | -10 | μA |
| | | $V_{GS} = 8 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | 10 | μA |
| | | $V_{GS} = -4.5 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | -1 | μA |
| | | $V_{GS} = 4.5 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | 1 | μA |
| | | $V_{GS} = -2.5 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | -200 | nA |
| | | $V_{GS} = 2.5 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | - | 200 | nA |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = -4.5 V$; $I_D = -3.0 A$; $T_j = 25 \text{ }^\circ C$ | - | 19 | 25 | m Ω |
| | | $V_{GS} = -4.5 V$; $I_D = -3.0 A$; $T_j = 150 \text{ }^\circ C$ | - | 26 | 34 | m Ω |
| | | $V_{GS} = -2.5 V$; $I_D = -3.0 A$; $T_j = 25 \text{ }^\circ C$ | - | 25 | 33 | m Ω |
| | | $V_{GS} = -1.8 V$; $I_D = -1.0 A$; $T_j = 25 \text{ }^\circ C$ | - | 37 | 60 | m Ω |
| g_{fs} | forward transconductance | $V_{DS} = -6.0 V$; $I_D = -3.0 A$; $T_j = 25 \text{ }^\circ C$ | - | 13 | - | S |
| R_G | gate resistance | $f = 1 \text{ MHz}$ | - | 12.6 | - | Ω |
| Dynamic characteristics | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS} = -6 V$; $I_D = -3 A$; $V_{GS} = -4.5 V$; $T_j = 25 \text{ }^\circ C$ | - | 19.6 | 29.4 | nC |
| Q_{GS} | gate-source charge | | - | 2.7 | - | nC |
| Q_{GD} | gate-drain charge | | - | 5 | - | nC |
| C_{iss} | input capacitance | $V_{DS} = -6 V$; $f = 1 \text{ MHz}$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | 1400 | - | pF |
| C_{oss} | output capacitance | | - | 430 | - | pF |
| C_{rss} | reverse transfer capacitance | | - | 400 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS} = -6 V$; $I_D = -6 A$; $V_{GS} = -4.5 V$; $R_{G(ext)} = 6 \Omega$; $T_j = 25 \text{ }^\circ C$ | - | 8 | - | ns |
| t_r | rise time | | - | 51 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | - | 72 | - | ns |
| t_f | fall time | | - | 62 | - | ns |
| Source-drain diode | | | | | | |
| V_{SD} | source-drain voltage | $I_S = -1.2 A$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ C$ | - | -0.9 | -1.2 | V |

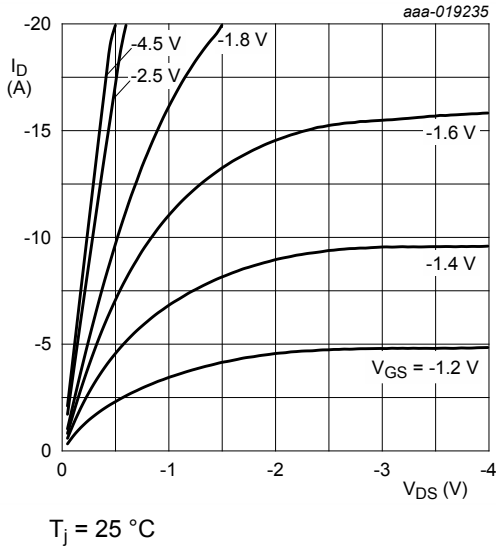


Fig. 7. Output characteristics: drain current as a function of drain-source voltage; typical values

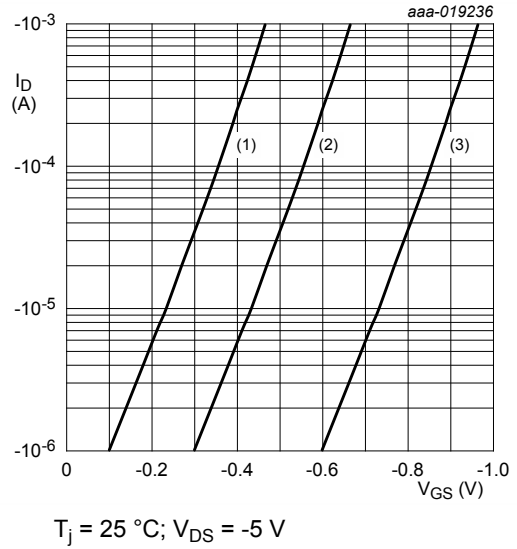


Fig. 8. Sub-threshold drain current as a function of gate-source voltage

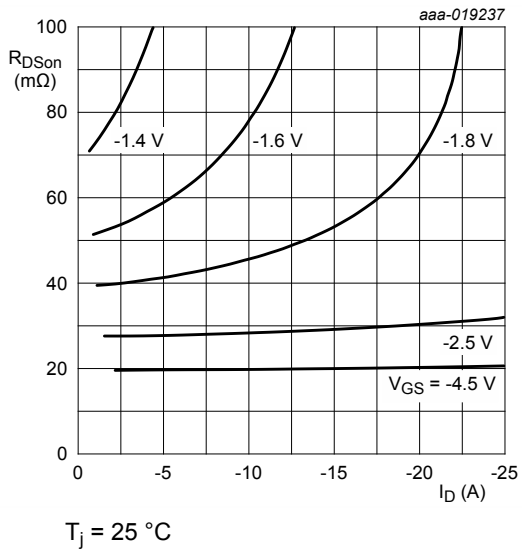


Fig. 9. Drain-source on-state resistance as a function of drain current; typical values

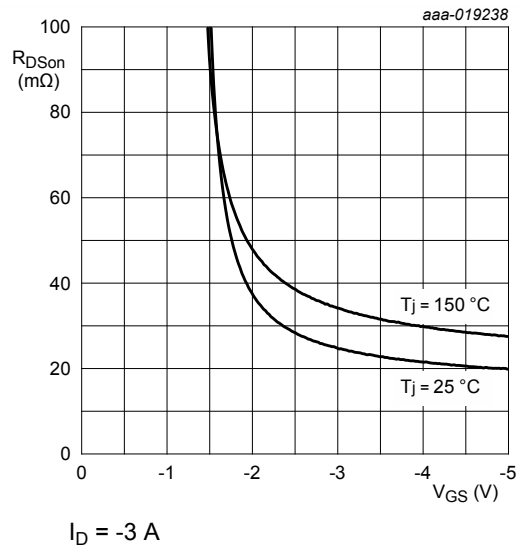
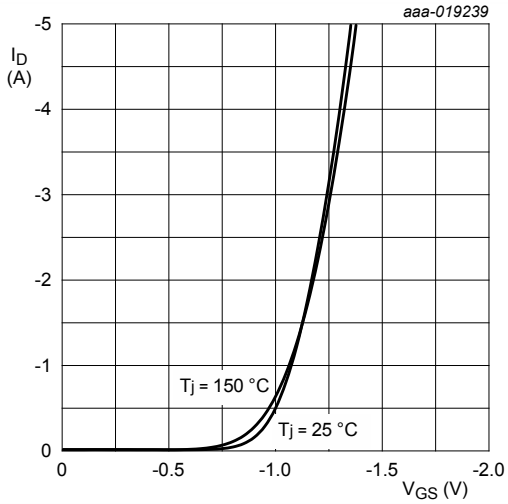


Fig. 10. Drain-source on-state resistance as a function of gate-source voltage; typical values



$$V_{DS} > I_D \times R_{DSon}$$

Fig. 11. Transfer characteristics: drain current as a function of gate-source voltage; typical values

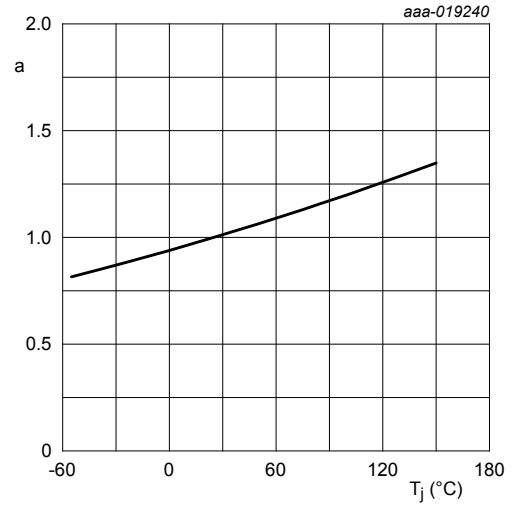
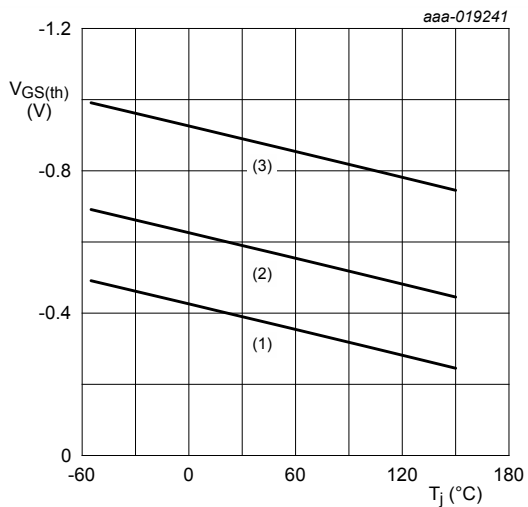


Fig. 12. Normalized drain-source on-state resistance as a function of junction temperature; typical values

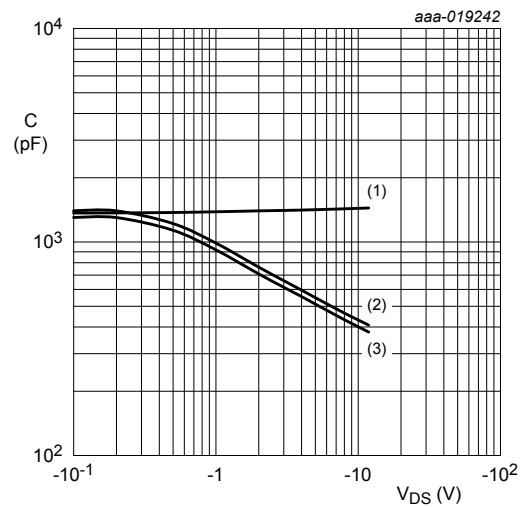
$$a = \frac{R_{DSon}}{R_{DSon(25^\circ C)}}$$



$$I_D = -0.25 \text{ mA}; V_{DS} = V_{GS}$$

- (1) minimum values
- (2) typical values
- (3) maximum values

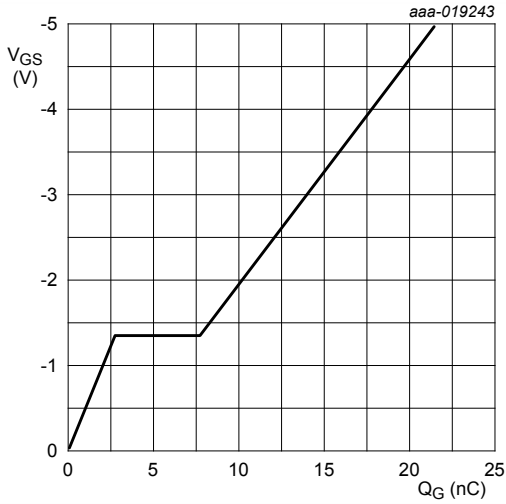
Fig. 13. Gate-source threshold voltage as a function of junction temperature



$$f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}$$

- (1) C_{iss}
- (2) C_{oss}
- (3) C_{rss}

Fig. 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$I_D = -3$ A; $V_{DS} = -6$ V; $T_{amb} = 25$ °C

Fig. 15. Gate-source voltage as a function of gate charge; typical values

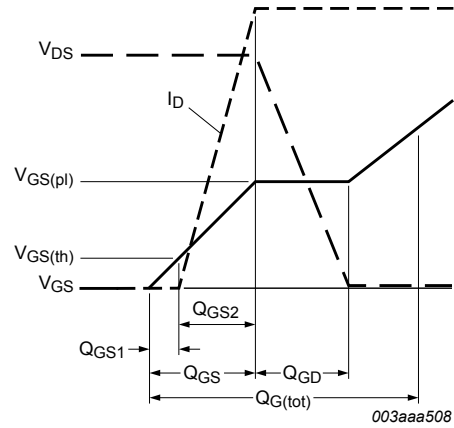
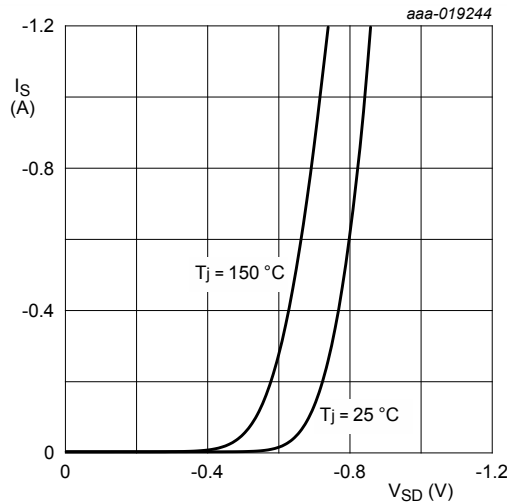


Fig. 16. MOSFET transistor: Gate charge waveform definitions



$V_{GS} = 0$ V

Fig. 17. Source current as a function of source-drain voltage; typical values

11. Test information

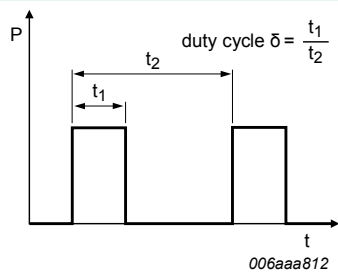


Fig. 18. Duty cycle definition

12. Package outline

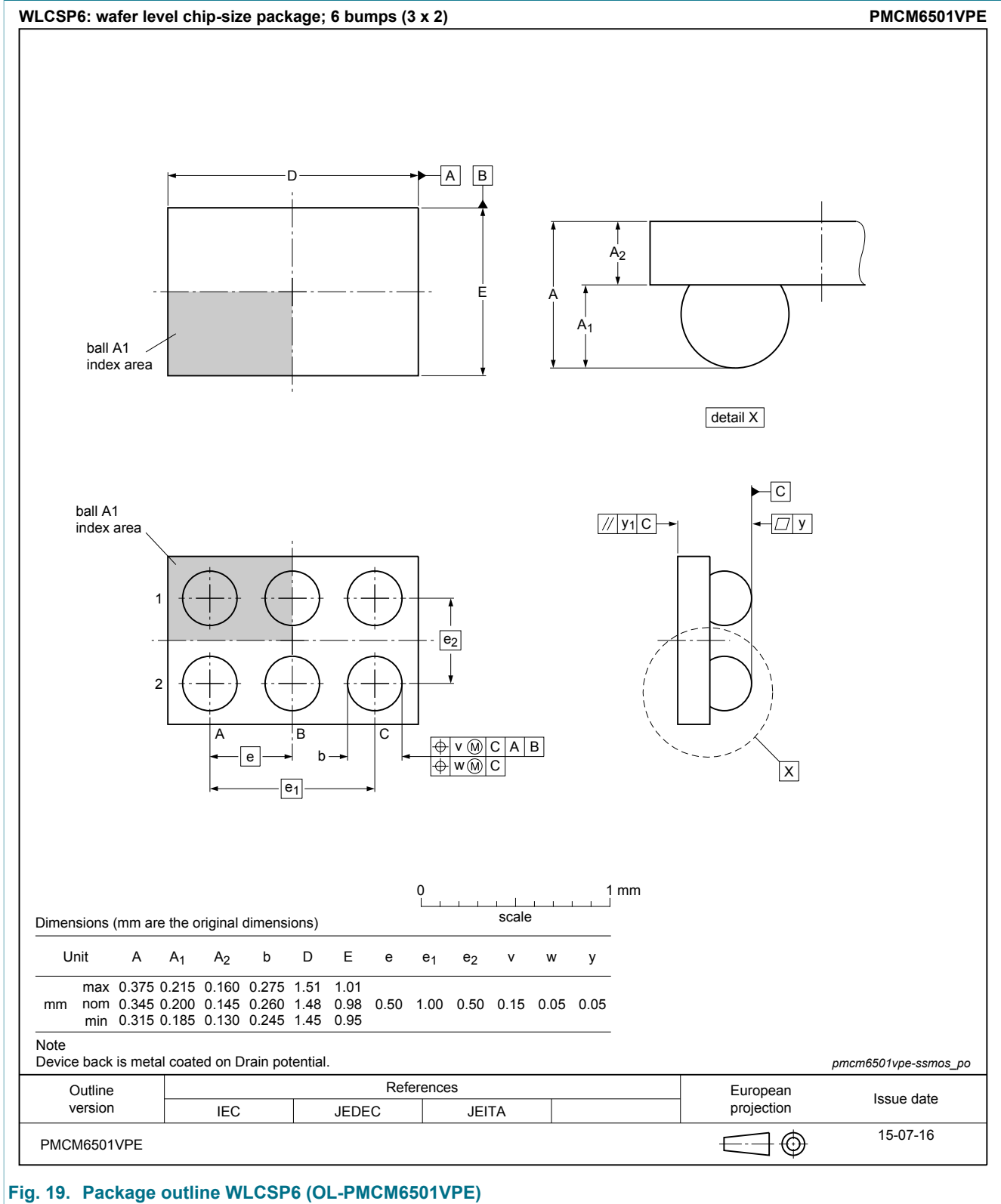


Fig. 19. Package outline WLCSP6 (OL-PMCM6501VPE)

13. Soldering

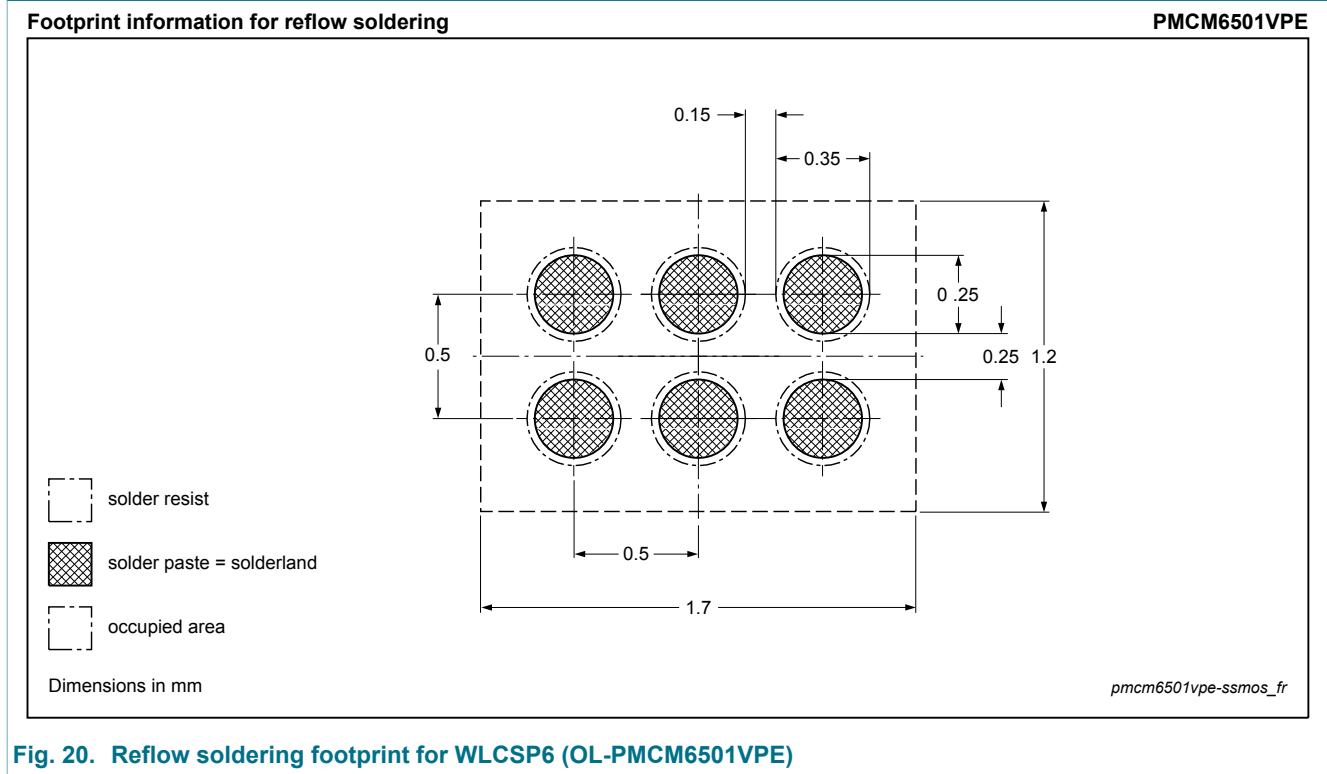


Fig. 20. Reflow soldering footprint for WLCSP6 (OL-PMCM6501VPE)

14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|--------------|--------------------|---------------|------------|
| PMCM6501VPE v.1 | 20150810 | Product data sheet | - | - |

15. Legal information

15.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
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| Product [short] data sheet | Production | This document contains the product specification. |

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Date of release: 10 August 2015